

P-Channel 60-V (D-S) MOSFET

PRODU	PRODUCT SUMMARY			
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)	
- 60	0.019 at V _{GS} = - 10 V	- 80	76 nC	
- 60	0.025 at V _{GS} = - 4.5 V	- 70	76110	

FEATURES

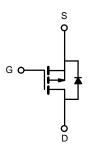
- TrenchFET® Power MOSFET
- 100 % UIS Tested

RoHS

APPLICATIONS

Load Switch





P-Channel	MOCEET
r-Channer	MOSEL

ABSOLUTE MAXIMUM RATINGS Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 60			
Gate-Source Voltage		V_{GS}	± 20	V	
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C		- 80 ^a	А	
	T _C = 70 °C	,	- 70		
	T _A = 25 °C	l _D	9.2 ^b		
	T _A = 70 °C		- 8.1 ^b		
Pulsed Drain Current		I _{DM}	- 150		
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	- 45		
L = 0.1 mH		E _{AS}	101	mJ	
Continuous Source-Drain Diode Current	T _C = 25 °C	1	69 ^a	۸	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.1 ^b	Α	
	T _C = 25 °C		104.2 ^a		
Maximum Power Dissipation	T _C = 70 °C		66.7 ^a	W	
	T _A = 25 °C	P _D	3.1 ^b		
	T _A = 70 °C		2 ^b		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	33	40	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	0.98	1.2	- C/VV	

Notes:

- a. Based on T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.

服务热线:400-655-8788

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		68		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1 _D = - 230 μΑ		- 5.2		IIIV/ C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	1	V _{DS} = - 60 V, V _{GS} = 0 V			- 1	μА	
	I _{DSS}	V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 55 °C			- 10		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 120			Α	
Drain-Source On-State Resistance ^a	Б	V _{GS} = - 10 V, I _D = - 30 A		0.019		Ω	
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 20 A		0.025			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 50 A	20			S	
Dynamic ^b				1	'		
Input Capacitance	C _{iss}			3500		pF	
Output Capacitance	C _{oss}	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		390			
Reverse Transfer Capacitance	C _{rss}			290			
Tatal Oats Ohanna		V _{DS} = - 30 V, V _{GS} = - 10 V, I _D = - 55 A		76			
Total Gate Charge	Qg			38		nC	
Gate-Source Charge	Q_{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -55 \text{ A}$		16			
Gate-Drain Charge	Q_{gd}			19			
Gate Resistance	R _g	f = 1 MHz		5.2		Ω	
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	t _r	$V_{DD} = -2 V, R_L = 2 \Omega$		7	15	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 10 V, R_g = 1 Ω		70	110		
Fall Time	t _f			40	60		
Drain-Source Body Diode Characteristic	s					•	
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 69	А	
Pulse Diode Forward Current ^a	I _{SM}				- 150		
Body Diode Voltage	V_{SD}	I _S = - 30 A		- 1	- 1.5	V	
Body Diode Reverse Recovery Time	t _{rr}			45	68	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	L _ 50 A di/dt _ 100 A/us T		59	120	nC	
Reverse Recovery Fall Time	t _a	$I_F = -50 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °C$		29			
Reverse Recovery Rise Time	t _b			16		ns	

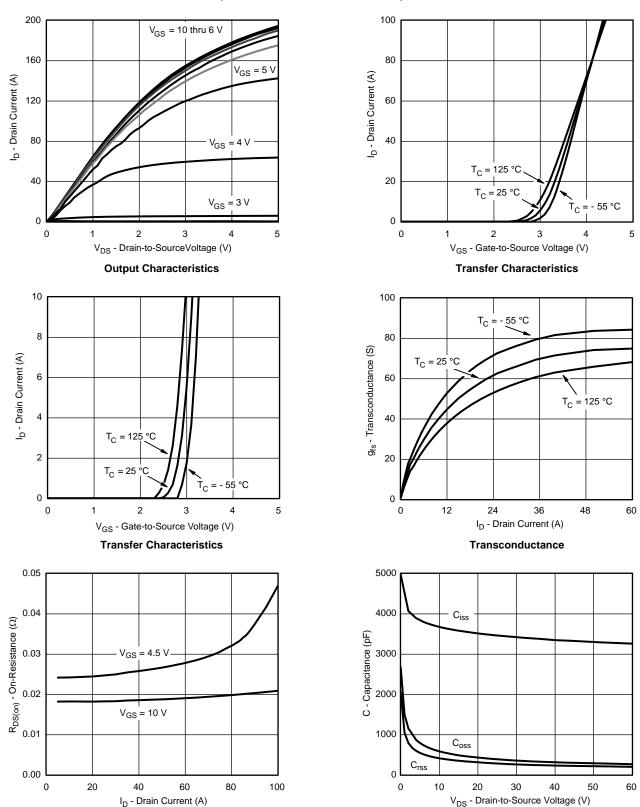
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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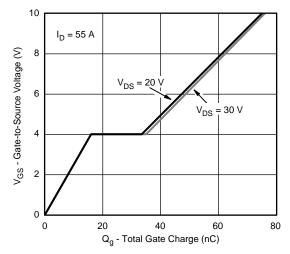
I_D - Drain Current (A)

On-Resistance vs. Drain Current

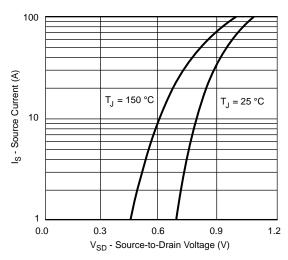
Capacitance



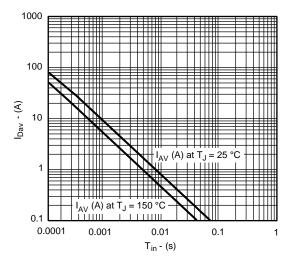
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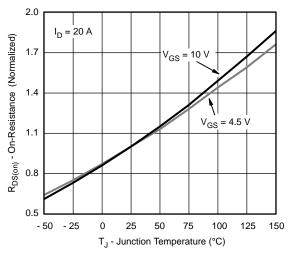




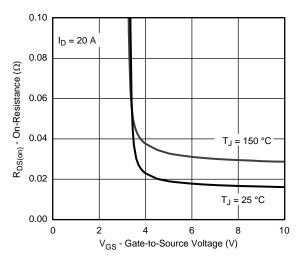
Source-Drain Diode Forward Voltage



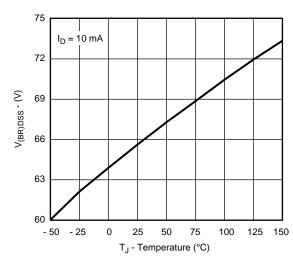
Single Pulse Avalanche Current Capability vs. Time



On-Resistance vs. Gate-to-Source Voltage



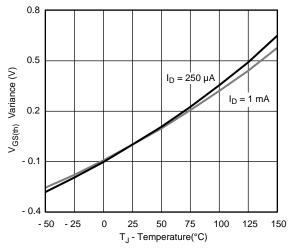
On-Resistance vs. Gate-to-Source Voltage

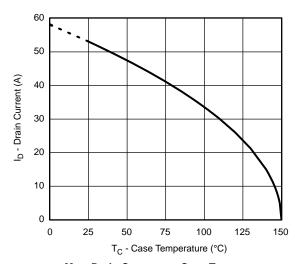


Drain-Source Breakdown Voltage vs. Junction Temperature

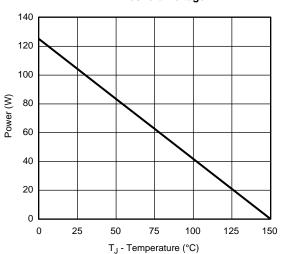


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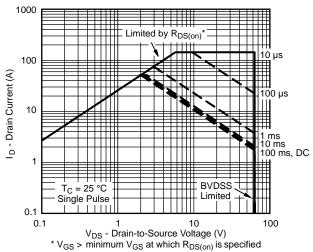




Threshold Voltage

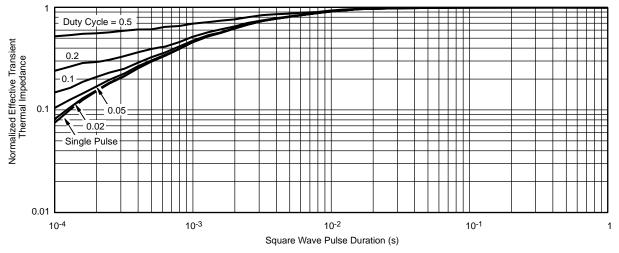


Max. Drain Current vs. Case Temperature



Power Derating, Junction-to-Case

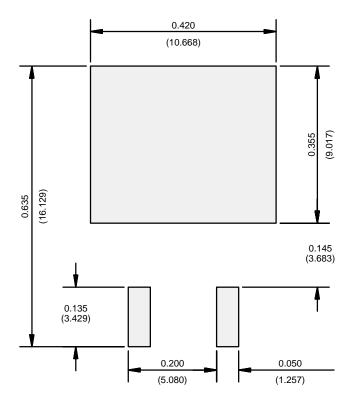




Normalized Thermal Transient Impedance, Junction-to-Case



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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